

A product Line of Diodes Incorporated



PI3PCIE3412

3.3V, PCI Express® 3.0 2-Lane, 2:1 Mux/DeMux Switch, with Single Enable

Features

- 4 Differential Channel, 2:1 Mux/DeMux
- PCI Express® 3.0 Performance, 8.0Gbps
- Bi-directional Operation
- Low Bit-to-Bit Skew, 10ps max
- Low channel-to-channel skew, 20ps max
- Low Crosstalk: -35dB@4 GHz
- High Off Isolation: -22dB@4 GHz (8.0Gbps)
- Low insertion loss: -1.3dB@4 GHz (8.0Gbps)
- Return loss: -21dB@4 GHz
- Support for DP1.2 HBR2, HBR, RBR
- Supply Voltage 3.3V
- Industrial Temperature Range: -40°C to 85°C
- Packaging (Pb-free & Green):
 - 42-contact, TQFN (ZH42), 3.5 x 9mm- 40-contact, TQFN (ZL40), 3 x 6mm

Pin Configuration - 40- Contact TQFN

Description

The PI3PCIE3412 is an 8 to 4 differential channel multiplexer/ demultiplexer switch. This solution can switch 2 full PCI Express® 3.0, lanes to one of two locations. Using a unique design technique, Diodes has been able to minimize the impedance of the switch such that the attenuation observed through the switch is minimal. The unique design technique also offers a layout targeted for PCI Express signals, which minimizes the channel to channel skew as well as channel to channel crosstalk as required by the PCI Express specification. PI3PCIE3412 can also be used for application up to 12Gbps

Application

Routing of PCI Express 3.0, DP1.2, USB3.0, SAS2.0, SATA3.0, XAUI, RXAUI signals with low signal attenuation.

Pin Configuration - 42- Contact TQFN

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Block Diagram







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Pin Description

Pin #							
42-TQFN	40-TQFN	Pin Name	I/O	Description			
2	1	A0+	1/0				
3	2	A0-	I/O	Signal I/O, Channel 0, Port A			
6	4	A1+	LO	Simult/O Changelt Dert A			
7	5	A1-	I/O	Signal I/O, Channel 1, Port A			
11	9	A2+	I/O	Signal I/O, Channel 2, Port A			
12	10	A2-	1/0	Signal 1/0, Chainer 2, Fort A			
15	13	A3+	I/O	Signal I/O, Channel 3, Port A			
16	14	A3-	1/0	Signal 1/0, Chaimers, Folt A			
38	36	B0+	I/O	Signal I/O, Channel 0, Port B			
37	35	B0-	1/0	Signal 1/0, Chainer 0, FOIT B			
36	34	B1+	I/O	Signal I/O, Channel 1, Port B			
35	33	B1-	1/0	Signal VO, Ghainiel I, FOILD			
29	26	B2+	I/O	Signal I/O, Channel 2, Port B			
28	25	B2-	1/0	Signal 1/0, Chainer 2, FOR b			
27	24	B3+	I/O	Signal I/O, Channel 3, Port B			
26	23	B3-	1/0				
34	32	C0+	I/O	Signal I/O, Channel 0, Port C			
33	31	C0-	1/0	Signal I/O, Chaimer 0, Port C			
32	30	C1+	I/O	Signal I/O, Channel 1, Port C			
31	29	C1-					
25	22	C2+	I/O	Signal I/O, Channel 2, Port C			
24	21	C2-	110				
23	20	C3+	I/O	Signal I/O, Channel 3, Port C			
22	19	С3-					
9	7	SEL	Ι	Operation mode Select (when SEL=0: $A \rightarrow B$, when SEL=1: $A \rightarrow C$			
5, 8, 13,18, 20, 30, 40, 42	3, 6, 11, 17, 28, 38	V _{DD}	Pwr	3.3V ±10% Positive Supply Voltage			
1, 4, 10, 14, 17, 19, 21, 39, 41, Center Pad	8, 12, 15, 16, 18, 27, 37, 39, 40	GND	Pwr	Power ground			





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Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	65°C to +150°C
Supply Voltage to Ground Potential	0.5V to +4.6V
Channel DC Input Voltage	–0.5V to 1.5V
DC Output Current	120mA
Power Dissipation	0.5W
SEL DC Input Voltage	–0.5V to 4.6V

Note: Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Electrical Characteristics

Recommended Operating Conditions

Symbol	Parameter	Conditions Min. Typ.	Max.	Units
V _{DD}	3.3V Power Supply	3.0 3.3	3.6	V
I _{DD}	Total current from V _{DD} 3.3V supply	SEL = 0V or V_{DD} 0.15	1	mA
V _{I/O} -DIF	Differential Voltage (differential pins)		1.6	V _{ppd}
V _{I/O-CM}	Common Mode Voltage (differiential pins)	0	0.8	V
T _A	Operating temperature range	-40	85	°C

DC Electrical Characteristics for Switching over Operating Range

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ. ⁽¹⁾	Max.	Units
V _{IH} - SEL	Input HIGH Voltage, SEL Input		2		3.6	
V _{IL} - SEL	Input LOW Voltage, SEL Input		0		0.8	V
V _{IK}	Clamp Diode Voltage	V_{DD} = Max., I_{IN} = -18mA		-0.7	-1.2	
IIH	Input HIGH Current, SEL	V_{DD} = Max., V_{IN} = V_{DD}			±5	
I _{IL}	Input LOW Current, SEL	$V_{DD} = Max., V_{IN} = 0V$			±5	μΑ
I _{IN} - SEL	Input Leakage Current, SEL Input	$V_{IN} = V_{IH}$ - SEL Max or V_{IL} - SEL Min	-10		+10	μΑ
IIH	Input HIGH Current, A _X , B _X , C _X	$V_{DD} = Max., V_{IN} = 1.5V$	-10		+10	۸
IIL	Input LOW Current, A _X , B _X , C _X	$V_{DD} = Max., V_{IN} = 0V$	-10		+10	μΑ
IOZH	HighZ HIGH Current, B _X , C _X	V_{DD} = Max., V_{IN} = 1.5V	-10		+10	μΑ
IOZL	HighZ LOW Current, B _X , C _X	$V_{DD} = Max., V_{IN} = 0V$	-10		+10	μΑ
C _{I/O} -ON	ON state I/O capacitance			1.5		pF
RON	ON state resistance	V_{DD} = 3.3V, IO = 8mA, V_{IN} = 0.8V		5		Ω

Note:

Typical values are at V_{DD} = 3.3V, T_A = 25°C ambient and maximum loading. 1.

Switching Characteristics

Parameters	Description	Test Conditions	Min.	Тур.	Max.	Units
t _{PZH} , t _{PZL}	Line Enable Time - SEL to A_N , B_N , C_N		2	20	25	
tpHZ, tPLZ	Line Disable Time - SEL to A_N , B_N , C_N		0.5	5	25 ns	
t _{b-b}	Bit-to-bit skew within the same differential pair			5	10	ps
tch-ch	Channel-to-channel skew				20	ps





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Dynamic Electrical Characteristics

Parameter	Description	Test Conditions	Min.	Typ. ⁽¹⁾	Max.	Units
		f= 50MHz - 1.25GHz		-0.8	-1	
	Differential Insertion Loss	f=1.25GHz - 2.5GHz		-1.0	-1.2	dB
DDIL	$(V_{IN} = -10 dBm, DC = 0V)$	f=2.5GHz - 4GHz		-1.3	-1.6	
		f=5GHz		-1.8	-2.2	
		f= 50MHz - 1.25GHz	-26.3	-32.9		
DDU		f=1.25GHz - 2.5GHz	-21.4	-26.7		10
DDIL _{OFF}	Differential Off Isolation	f=2.5GHz - 4GHz	-17.6	-22		dB
		f=5GHz	-16	-20		
		f= 50MHz - 1.25GHz	-20	-25		
DDRL	Differential Return Loss	f=1.25GHz - 2.5GHz	-18.4	-23		dB
DDRL		f=2.5GHz - 4GHz	-16.8	-21		ав
		f=5GHz	-9.6	-12		
	Near End Crosstalk	f= 50MHz - 1.25GHz	-34.1	-42.6		dB
DDNEXT		f=1.25GHz - 2.5GHz	-30.5	-38.1		
DDNLAT		f=2.5GHz - 4GHz	-28.1	-35.1		
		f=5GHz	-27.2	-34		
		Insertion loss 1.5dB, V _{IN} =0.623Vpp, DC=0V		4.0		GHz
V _{IF}	Max Signal Frequency Range	Insertion loss 1.5dB, V _{IN} =0.623Vpp, DC=0.9V		4.0		
		Insertion loss 3dB, V _{IN} =0.623Vpp, DC=0V		8.0		
		Insertion loss 3dB, V _{IN} =0.623Vpp, DC=0.9V		8.0		
BW	-3dB Bandwidth			8.2		GHz







Diff. Insertion Loss and Return Test Circuit

Diff. Off Isolation Test Circuit

Diff. Near End Xtalk Test Circuit



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Differential Return Loss





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Differential Crosstalk







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Test Circuit for Electrical Characteristics⁽¹⁻⁵⁾



Switch Positions

Test	Switch
t _{PLZ} , t _{PZL}	3.0V
t _{PHZ} , t _{PZH}	GND
Prop Delay	Open
Prop Delay	Open

Notes:

- C_{L} = Load capacitance: includes jig and probe capacitance. 1.
- R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator 2.
- Output 1 is for an output with internal conditions such that the output is low except when disabled by the output control. 3.
- Output 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- All input impulses are supplied by generators having the following characteristics: $PRR \le MHz$, $Z_O = 50\Omega$, $t_R \le 2.5$ ns. $t_F \le 2.5$ ns. 4.
- The outputs are measured one at a time with one transition per measurement. 5.

Switching Waveforms



Voltage Waveforms Enable and Disable Times





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DP1.2 Application







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Packaging Information







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Packaging Information



Note: For latest package info, please check: http://www.pericom.com/support/packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information		
Ordering Code	Package Code	Package Description
PI3PCIE3412ZLE	ZL	40-contact, Thin Fine Pitch Quad Flat No-Lead (TQFN)
PI3PCIE3412ZLEX	ZL	40-contact, Thin Fine Pitch Quad Flat No-Lead (TQFN), Tape & Reel
PI3PCIE3412ZHE	ZH	42-contact, Very Thin Quad Flat No-Lead (TQFN)
PI3PCIE3412ZHEX	ZH	42-contact, Very Thin Quad Flat No-Lead (TQFN), Tape & Reel

Notes:

Thermal characteristics can be found on the company web site at www.pericom.com/packaging/

"E" denotes Pb-free and Green

Adding an "X" at the end of the ordering code denotes tape and reel packaging





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